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JIANG CHYUN IPO

2008

JAN 26 2006

PART B - FEE(S) TRANSMITTAL.

Complete and send this form, together with applicable fee(s), to: Mail

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31361 7590 11/02/2005

JIANG CHYUN INTELLECTUAL PROPERTY OFFICE  
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I hereby certify that this Fee(s) Transmittal is being deposited with the United States Postal Service with sufficient postage for first class mail in an envelope addressed to the Mail Stop ISSUE FEE address above, or being facsimile transmitted to the USPTO (571) 273-2885, on the date indicated below.

(Depositor's name)  
(Signature)  
(Date)

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/605,602	10/13/2003	Sheng-Fei Wang	10233-US-PA	2501

TITLE OF INVENTION: [HEAT SINK FOR CHIP PACKAGE AND BONDING METHOD THEREOF]

APPLN. TYPE	SMALL ENTITY	ISSUE FEE	PUBLICATION FEE	TOTAL FEE(S) DUE	DATE DUE
nonprovisional	NO	\$1400	\$300	\$1700	02/02/2006
EXAMINER	ART UNIT	CLASS-SUBCLASS			
CHAN, SING P	1734	156-256000			

1. Change of correspondence address or indication of "Fee Address" (37 CFR 1.363).

Change of correspondence address (or Change of Correspondence Address form PTO/SB/122) attached.  
 "Fee Address" indication (or "Fee Address" indication form PTO/SB/47; Rev 03-02 or more recent) attached. Use of a Customer Number is required.

2. For printing on the patent front page, list

(1) the names of up to 3 registered patent attorneys or agents OR, alternatively,  
(2) the name of a single firm (having as a member a registered attorney or agent) and the names of up to 2 registered patent attorneys or agents. If no name is listed, no name will be printed.

1. \_\_\_\_\_  
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3. ASSIGNEE NAME AND RESIDENCE DATA TO BE PRINTED ON THE PATENT (print or type)

PLEASE NOTE: Unless an assignee is identified below, no assignee data will appear on the patent. If an assignee is identified below, the document has been filed for recordation as set forth in 37 CFR 3.11. Completion of this form is NOT a substitute for filing an assignment.

(A) NAME OF ASSIGNEE

(B) RESIDENCE: (CITY AND STATE OR COUNTRY)

Advanced Semiconductor Engineering, Inc. Kaohsiung, Taiwan, R.O.C.

Please check the appropriate assignee category or categories (will not be printed on the patent):  Individual  Corporation or other private group entity  Government

4a. The following fee(s) are enclosed:

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The Director is hereby authorized to charge the required fee(s), or credit any overpayment, to Deposit Account Number 50-2620 (enclose an extra copy of this form).

5. Change in Entity Status (from status indicated above)

a. Applicant claims SMALL ENTITY status. See 37 CFR 1.27.

b. Applicant is no longer claiming SMALL ENTITY status. See 37 CFR 1.27(e)(2).

The Director of the USPTO is requested to apply the Issue Fee and Publication Fee (if any) or to re-apply any previously paid issue fee to the application identified above. NOTE: The Issue Fee and Publication Fee (if required) will not be accepted from anyone other than the applicant, a registered attorney or agent, or the assignee or other party in interest as shown by the records of the United States Patent and Trademark Office.

Authorized Signature

*Belinda Lee*

Date

*Jan. 26, 2006*

Typed or printed name

*Belinda Lee*

46,863

Registration No.

This collection of information is required by 37 CFR 1.311. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 12 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form, and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, Virginia 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, Virginia 22313-1450.

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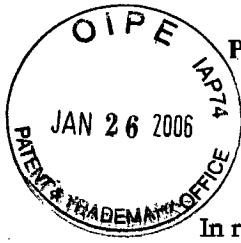
PTO-85 (Rev. 07/05) Approved for use through 04/30/2007.

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01/26/2006 HDEHES2 00000008 502620 10605602

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Patent

Customer No.: 31561  
 Docket No.: 10233-US-PA  
 Application No.: 10/605,602

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Applicant : Sung-Fei Wang  
 Application No. : 10/605,602  
 Filed : 2003/10/13  
 For : HEAT SINK FOR CHIP PACKAGE AND BONDING  
 METHOD THEREOF  
 Art Unit : 1734  
 Examiner : CHAN, SING P

TRANSMITTAL LETTER

002-1-571-273-2885

(Via fax : 1+2 pages)

Assistant Commissioner for Patents  
 Alexandria, VA 22314

Dear Sir,

In response to the Notice of Allowance and Fee(s) due, dated November 2, 2005, transmitted herewith please find the Issue Fee Transmittal (PTOL-85B) in duplicate.

Please charge the fee in the amount of \$1700.00 for Issue Fee and Publication Fee to Account No. 50-2620 (Order No.: 10233-US-PA).

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact me.

Respectfully Submitted,  
 JIANQ CHYUN Intellectual Property Office

Date : Jan. 26, 2006

By : Belinda Lee  
 Belinda Lee  
 Registration No.: 46,863

Please send future correspondence to:  
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